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# A+ Server 2123BT-HNC0R(Complete System Only)



1 COM port (header)

AMI 128Mb SPI Flash ROM

KVM with dedicated LAN

ACPI / APM Power Management

1 TPM 2.0 header

<u>IPMI 2.0</u>

SSM, SUM

Watch Dog

**Global Services & Support** OS4HR3/2/1

**TPM security module** AOM-TPM-9655V

SIOM -

OSNBD3/2/1

**Software** <u>SFT-DCMS-Single</u>

SuperDoctor® 5

Others

**BIOS Type** 

Software

**System BIOS (per Node)** 

**Management (per Node)** 

**Power Configurations** 

Parts List - (Items Included)



Views: Angled View Node View Front View Rear View

minimum 2 CPUs, 8 DIMMs, 1 HDD/NVMe and 1 SIOM card per node).

Complete System Only: To maintain quality and integrity, this product is sold only as a completely-assembled system (with

**Drive Options** 

<u>Drivers & Utilities</u> <u>BIOS</u> <u>IPMI</u> <u>Tested Memory</u> <u>Tested M.2 List</u> <u>NVMe Options</u> <u>Tested AOC</u> <u>Manuals</u> <u>OS Certification Matrix</u> <u>Quick-References Guide</u>

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

## **Key Features**

- Compute Intensive Application - HPC, Data Center, Enterprise Server

- Hyperscale / Hyperconverged

### Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Dual AMD EPYC™ 7001/7002\* Series Processors (\*AMD EPYC 7002 series drop-in support requires board revision 2.x)
- 2. 2TB Registered ECC DDR4 2666MHz SDRAM in 16 DIMMs (7001 Processors) 4TB Registered ECC DDR4 3200MHz SDRAM in 16 DIMMs
- (Board revision 2.x required + 7002 Processors) 3. 2 PCI-E 3.0 x16 (LP) slot; 1 SIOM card support (flexible networking)\_
- Note: must bundle with Network card 4. Integrated IPMI 2.0 + KVM with dedicated LAN Software Out of Band License
- key (SFT-OOB-LIC) included for OOB BIOS management 5. 6 SAS3, or 4 NVMe + 2 SAS3 Hot-swap 2.5" drive bays M.2 Interface: 1 SATA/PCI-E 3.0 x4
- **M.2 Form Factor**: 2280, 22110 M.2 Key: M-key 6. SAS3 support via Broadcom 3008; IT mode
- 7. Video via Aspeed AST2500 BMC

8. 2200W Redundant Power Supplies

Titanium Level (96%) (Full redundancy based on configuration and application load)



	Specif	ications ^	
Product SKUs - Discontinued	I SKU (EOL). Please contact sales-rep for alternative options.	Chassis	
AS -2123BT-HNCOR	A+ Server 2123BT-HNC0R ( <b>Black</b> )	Form Factor	2U Rackmount
Motherboard (per Node)		Model	CSE-217BHQ+-R2K22BP2
Super H11DST-B		Dimensions and Weight	
Processor/Chipset (per Node	e)	Width	17.68" (449mm)
CDU	D. J.AMD EDVCTM 7004 /7003* D.	Height	3.47" (88mm)
CPU	Dual AMD EPYC™ 7001/7002* series Processors (* Board revision 2.x required)	Depth	28.75" (730mm)
	Socket SP3	Package	24.33" (618mm) H x 9.57" (243mm) W x 45.08" (1145mm) D
	Supports CPU TDP 200W / cTDP up to 200W**	Weight	Gross Weight: 85 lbs (38.6 kg) Net Weight: 54.5 lbs (24.7 kg)
Cores	Up to 32 Cores (Board revision 1.x + 7001 Processors) Up to 64 Cores (Board revision 2.x + 7002 Processors)	Available Colors	Black
Note	** Certain CPUs with high TDP may be supported only under	Front Panel (per Node)	
	specific conditions. Please contact Supermicro Technical Support for additional information about specialized system optimization	Buttons	Power On/Off button UID button
System Memory (per Node)		LEDs	Power status LED
Memory Capacity	16 DIMM slots		HDD activity LED  Network activity LEDs  Universal Information (UID) LED
	Supports up to 2TB Registered ECC DDR4 2666MHz SDRAM (7001 Processors)	Expansion Slots (per Node)	
	Supports up to 4TB Registered ECC DDR4 3200MHz SDRAM (Board revision 2.x required + 7002 Processors) 8-channel memory bus	PCI-Express	2 PCI-E 3.0 (x16) Low-profile slots 1 <u>SIOM</u> card support
	For Dual CPUs: Recommended that memory be populated equally in adjacent memory banks	M 2	(must bundle with network card)
Memory Type	DDR4 2666 MHz Registered ECC, 288-pin gold-plated DIMMs (7001 Processors) DDR4 3200 MHz Registered ECC, 288-pin gold-plated DIMMs	M.2	Interface: 1 SATA/PCI-E 3.0 x4 Form Factor: 2280, 22110 Key: M-key
	(Board revision 2.x required + 7002 Processors)	Drive Bays (per Node)	
Memory Sizes	8GB, 16GB, 32GB, 64GB, 128GB, 256GB* (* Board revision 2.x required + 7002 processors)	Hot-swap	6 Hot-swap 2.5" SAS3 drive bays or 4 NVMe + 2 SAS3 Hot-swap 2.5"
Memory Voltage	1.2V		Note: NVMe Gen4 drives may only operate at Gen3 speed
Error Detection	Corrects single-bit errors Detects double-bit errors (using ECC memory)	System Cooling	
On-Board Devices (per Node		Fans	4 Heavy duty 8cm PWM fans
Chipset	System on Chip	Power Supply	
SAS	SAS3 (12Gbps) via Broadcom 3008; IT mode		plice with DMD.
Network	1 PCI-E 3.0 x16 SIOM LAN Networking Slot for flexible	2200W Redundant Power Sup  Total Output Power	
	networking, see <u>SIOM</u> LAN options support matrix (Must	Dimension	1200W/1800W/1980W/2090/2200W 45 x 40 x 480 mm
IPMI	bundle with at least one SIOM network card)  Support for Intelligent Platform Management Interface v.2.0	(W x H x L)	43 X 40 X 400 IIIII
II IVII	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support	Input	1200W: 100-127Vac / 50-60Hz 1800W: 200-220Vac / 50-60Hz
Video	ASPEED AST2500 BMC		1980W: 220-230Vac / 50-60Hz 2090W: 230-240Vac / 50-60Hz
Input / Output (per Node)			2090W: 180-220Vac (for UL/cUL only) 2200W: 220-240Vac (for UL/cUL only)
LAN	Provided via SIOM (optional) 1 RJ45 Dedicated IPMI LAN port	+12V	2090W: 230-240Vdc (for CCC only) Max: 100A / Min: 0A (100-127Vac)
USB	2 USB 3.0 ports (rear)		Max: 150A / Min: 0A (200-220Vac)
Video	1 VGA port		Max: 165A / Min: 0A (220-230Vac) Max: 174.17A / Min: 0A (230-240Vac)
DOM	1 Super <u>DOM</u> (Disk on Module) port		Max: 174.17A / Min: 0A (180-220Vac, UL/cUL only)
- · ·	4.0014 // /		May: 184 440 / MID: 110 / / // // // // // // // // // // // /

## RoHS **Environmental Spec.**

**Operating Environment** 

10°C ~ 30°C (50°F ~ 86°F) \* Support for operating above 30°C is available in certain

12Vsb

**Output Type** 

Certification

system configurations. Contact your Supermicro sales rep or Technical Support for more details. Non-operating Temperature:

-40°C to 60°C (-40°F to 140°F)

Operating Temperature:

Max: 2.1A / Min: 0A

**RoHS Compliant** 

**Gold Finger** 

Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)

Max: 183.33A / Min: 0A (220-240Vac, UL/cUL only)

Max: 174.17A / Min: 0A (230-240Vdc, CCC only)

Titanium Level

[ Test Report ]

Parts List ^

	Part Number	Qty	Description
Motherboard / Chassis		4	Super H11DST-B Motherboard
	CSE-217BHQ+-R2K22BP2	1	2U Chassis
Backplane	BPN-ADP-6S3008N4-1UB	4	Big Twin 1U hybrid ADP supporting 6x SAS3 and 4x NVMe
Backplane	BPN-SAS3-217BHQ-N4	1	2U 4-Node 24-Port Backplane Supports 2x2.5\" SATA3/SAS3 SSD/HDD and 4x2.5\" SATA3/SAS3/NVMe Stoage Media per Node
Drive Tray(s)	MCP-220-00141-0B-BULK	8	Black Gen3 hot-swap 2.5 inch HDD tray with lock improved EMI
Drive Tray(s)	MCP-220-00144-0B-BULK	16	Black Gen3 hot-swap 2.5 inch HDD tray with lock, orange tab
Parts	MCP-240-21730-0N	1	217B BigTwin type I (Impact) BPN retention bkt w/ foam assy
Riser Card	RSC-P-6	4	RSC-P-6 (1U LHS TwinPro RSC with 1 PCI-Ex16),RoHS
Riser Card	RSC-R1UTP-E16R	4	1U RHS TwinPro Riser card with one PCI-E x16 slot
Software	SFT-OOB-LIC	4	License key for enabling OOB BIOS management
Heatsink / Retention	SNK-P0062PM	4	1U Passive Front CPU Heat Sink w/ a 30-mm Wide Middle Air Channel for AMD H11 2U4N Big Twin Series Servers
Heatsink / Retention	SNK-P0062PW	4	1U Proprietary 93-mm Wide Passive Rear CPU Heat Sink for AMD H11 2U4N Big Twin Series Servers
Power Supply	PWS-2K22A-1R	2	1U 2200W Redundant Power Supply Titanium, 45(W) X 40(H) X 48
FAN	FAN-0183L4	4	80x80x38 mm, 16.5K RPM, Non-hot-swappable Middle Cooling Fan for X11 Twin Pro, X10 and X11 Big Twin Series Servers
Optional Parts List			
	Part Number	Qty	Description

1

<u>AOM-TPM-9665V</u> -









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3/2/1-year onsite 24x7x4 service

Supermicro SIOM solutions [Details]

DataCenter Management Package (per node license)

TPM 1.2 module with Infineon 9655, RoHS/REACH, PBF;

TPM 2.0 module with Infineon 9665, RoHS/REACH, PBF;

3/2/1-year onsite NBD service

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